

2SK3568

Switching Regulator Applications

- Low drain-source ON-resistance:  $R_{DS(ON)} = 0.4\ \Omega$  (typ.)
- High forward transfer admittance:  $|Y_{fs}| = 8.5\ S$  (typ.)
- Low leakage current:  $I_{DSS} = 100\ \mu A$  ( $V_{DS} = 500\ V$ )
- Enhancement mode:  $V_{th} = 2.0\ to\ 4.0\ V$  ( $V_{DS} = 10\ V, I_D = 1\ mA$ )

Absolute Maximum Ratings ( $T_a = 25^{\circ}C$ )

Characteristics		Symbol	Rating	Unit
Drain-source voltage		$V_{DSS}$	500	V
Drain-gate voltage ( $R_{GS} = 20\ k\Omega$ )		$V_{DGR}$	500	V
Gate-source voltage		$V_{GSS}$	$\pm 30$	V
Drain current	DC (Note 1)	$I_D$	12	A
	Pulse ( $t = 1\ ms$ ) (Note 1)	$I_{DP}$	48	
Drain power dissipation ( $T_c = 25^{\circ}C$ )		$P_D$	40	W
Single pulse avalanche energy (Note 2)		$E_{AS}$	364	mJ
Avalanche current		$I_{AR}$	12	A
Repetitive avalanche energy (Note 3)		$E_{AR}$	4	mJ
Channel temperature		$T_{ch}$	150	$^{\circ}C$
Storage temperature range		$T_{stg}$	-55 to 150	$^{\circ}C$

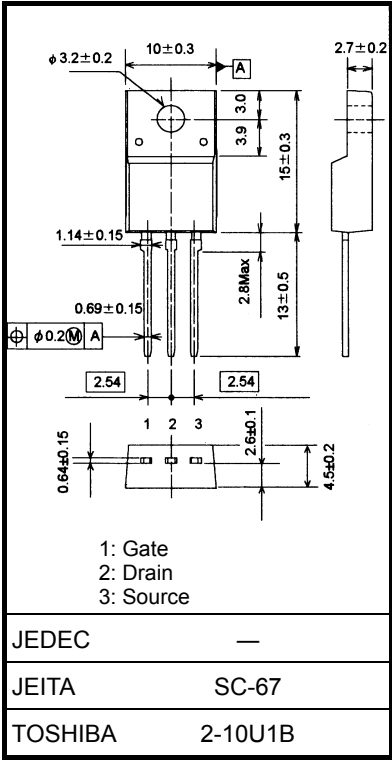
Note: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings. Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc.).

Thermal Characteristics

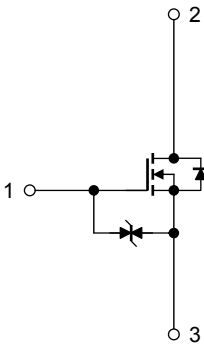
Characteristics	Symbol	Max	Unit
Thermal resistance, channel to case	$R_{th(ch-c)}$	3.125	$^{\circ}C/W$
Thermal resistance, channel to ambient	$R_{th(ch-a)}$	62.5	$^{\circ}C/W$

- Note 1: Ensure that the channel temperature does not exceed  $150^{\circ}C$ .
- Note 2:  $V_{DD} = 90\ V, T_{ch} = 25^{\circ}C$  (initial),  $L = 4.3\ mH, I_{AR} = 12\ A, R_G = 25\ \Omega$
- Note 3: Repetitive rating: pulse width limited by maximum channel temperature
- This transistor is an electrostatic-sensitive device. Handle with care.

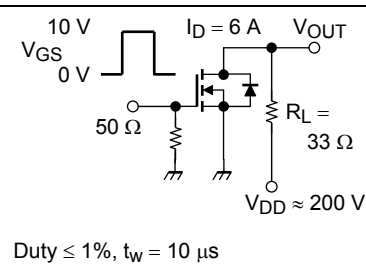
Unit: mm



Weight : 1.7 g (typ.)



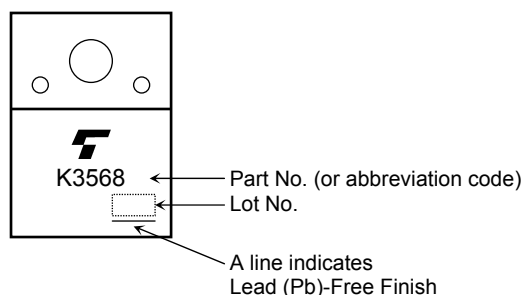
## Electrical Characteristics (Ta = 25°C)

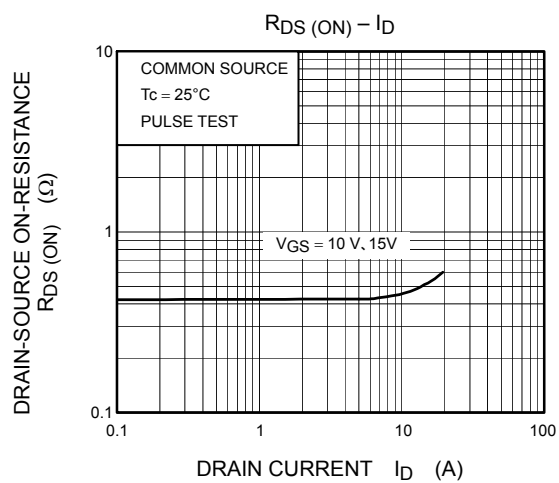
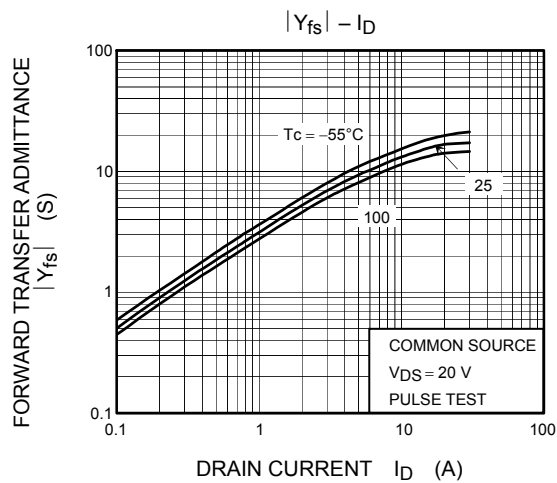
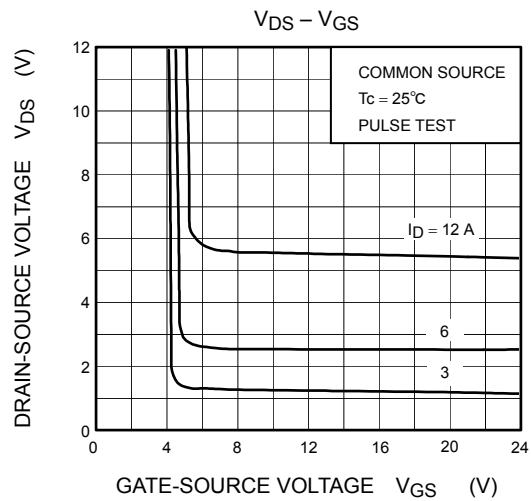
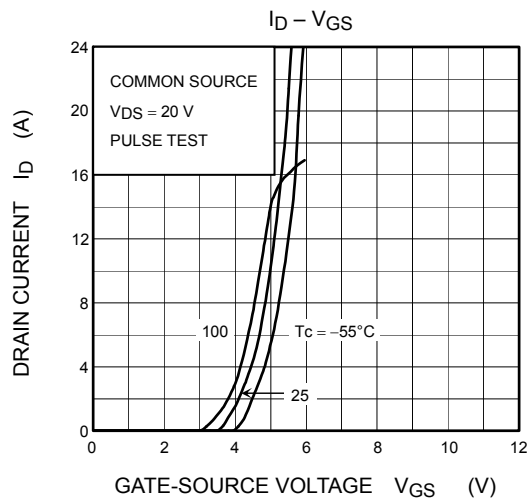
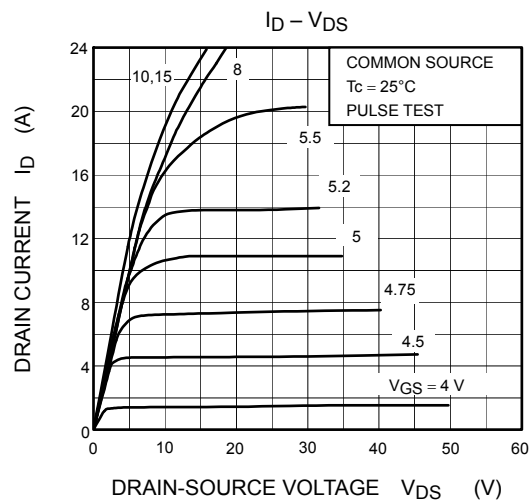
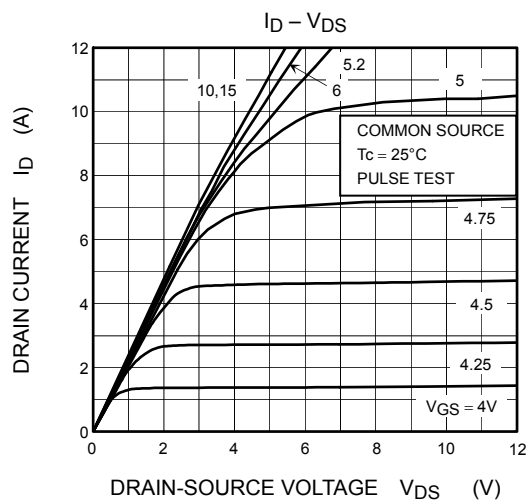
Characteristics		Symbol	Test Condition	Min	Typ.	Max	Unit
Gate leakage current		$I_{GSS}$	$V_{GS} = \pm 25 \text{ V}, V_{DS} = 0 \text{ V}$	—	—	$\pm 10$	$\mu\text{A}$
Gate-source breakdown voltage		$V_{(BR) GSS}$	$I_G = \pm 10 \mu\text{A}, V_{DS} = 0 \text{ V}$	$\pm 30$	—	—	V
Drain cut-off current		$I_{DSS}$	$V_{DS} = 500 \text{ V}, V_{GS} = 0 \text{ V}$	—	—	100	$\mu\text{A}$
Drain-source breakdown voltage		$V_{(BR) DSS}$	$I_D = 10 \text{ mA}, V_{GS} = 0 \text{ V}$	500	—	—	V
Gate threshold voltage		$V_{th}$	$V_{DS} = 10 \text{ V}, I_D = 1 \text{ mA}$	2.0	—	4.0	V
Drain-source ON-resistance		$R_{DS(ON)}$	$V_{GS} = 10 \text{ V}, I_D = 6 \text{ A}$	—	0.4	0.52	$\Omega$
Forward transfer admittance		$ Y_{fs} $	$V_{DS} = 10 \text{ V}, I_D = 6 \text{ A}$	3.5	8.5	—	S
Input capacitance		$C_{iss}$	$V_{DS} = 25 \text{ V}, V_{GS} = 0 \text{ V}, f = 1 \text{ MHz}$	—	1500	—	pF
Reverse transfer capacitance		$C_{rss}$		—	15	—	
Output capacitance		$C_{oss}$		—	180	—	
Switching time	Rise time	$t_r$		—	22	—	ns
	Turn-on time	$t_{on}$		—	50	—	
	Fall time	$t_f$		—	36	—	
	Turn-off time	$t_{off}$		—	170	—	
Total gate charge		$Q_g$	$V_{DD} \approx 400 \text{ V}, V_{GS} = 10 \text{ V}, I_D = 12 \text{ A}$	—	42	—	nC
Gate-source charge		$Q_{gs}$		—	23	—	
Gate-drain charge		$Q_{gd}$		—	19	—	

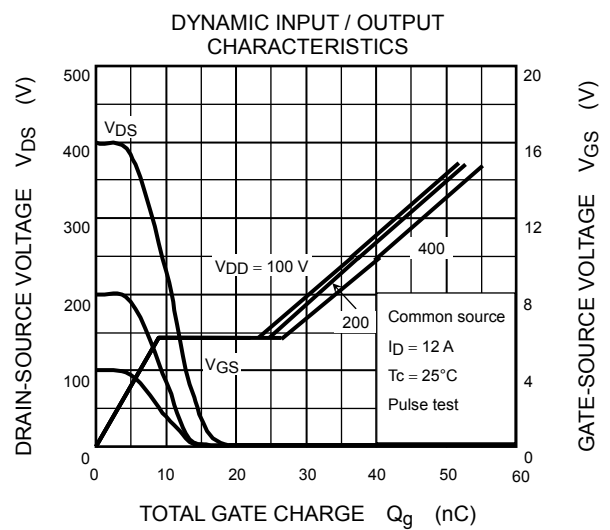
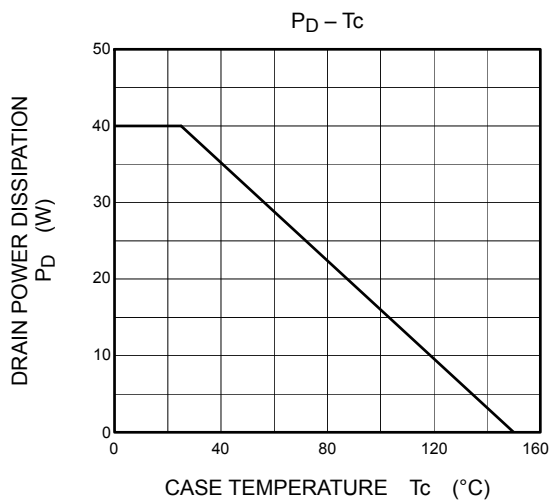
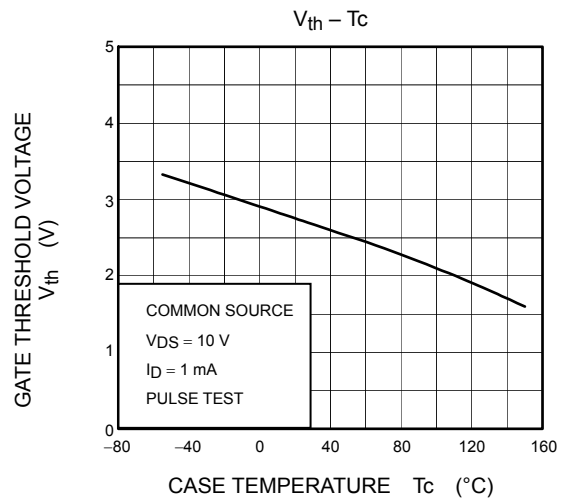
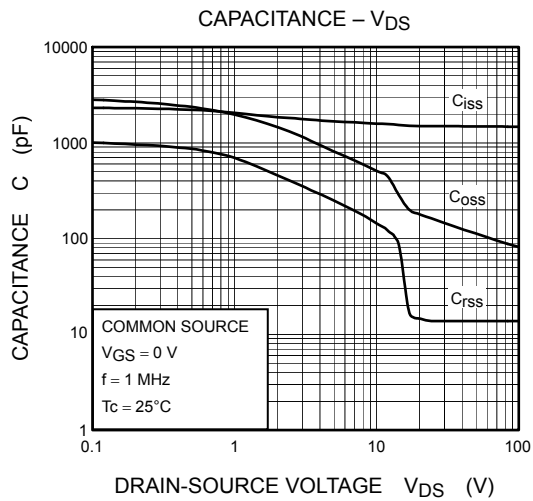
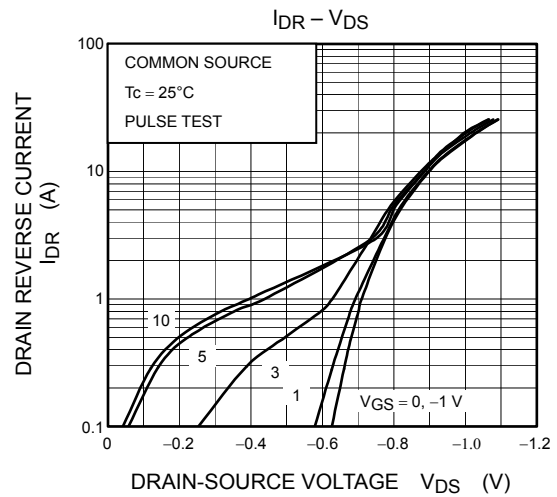
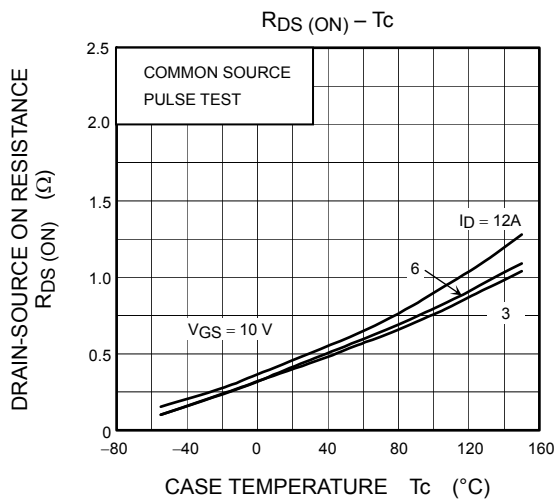
## Source-Drain Ratings and Characteristics (Ta = 25°C)

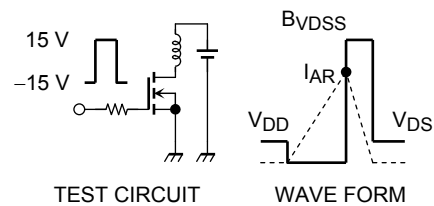
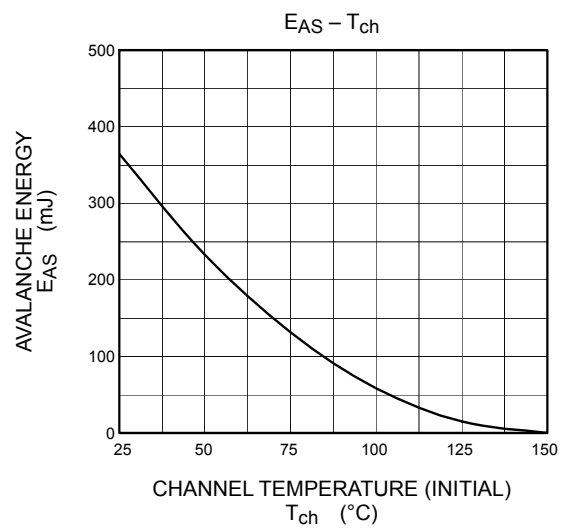
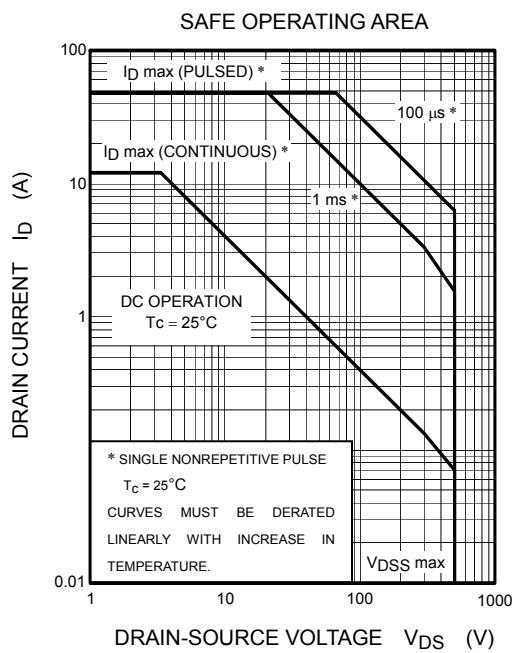
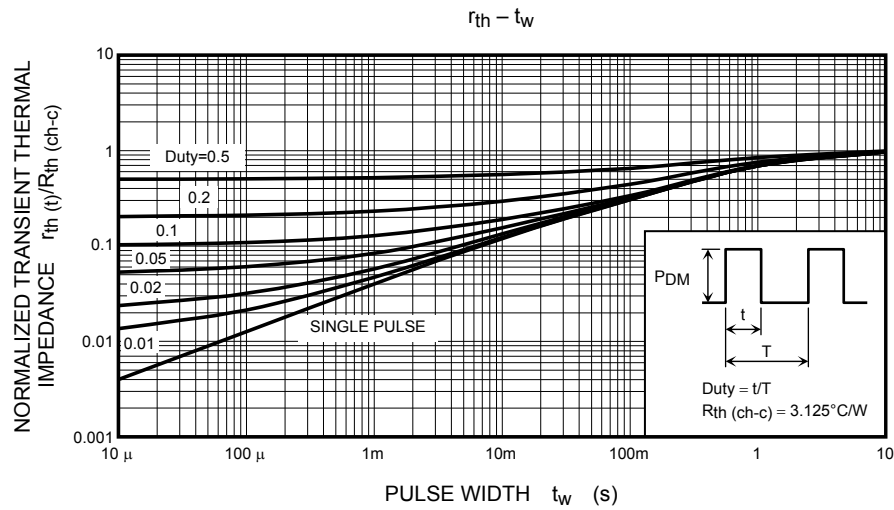
Characteristics	Symbol	Test Condition	Min	Typ.	Max	Unit
Continuous drain reverse current (Note 1)	$I_{DR}$	—	—	—	12	A
Pulse drain reverse current (Note 1)	$I_{DRP}$	—	—	—	48	A
Forward voltage (diode)	$V_{DSF}$	$I_{DR} = 12 \text{ A}, V_{GS} = 0 \text{ V}$	—	—	-1.7	V
Reverse recovery time	$t_{rr}$	$I_{DR} = 12 \text{ A}, V_{GS} = 0 \text{ V},$	—	1200	—	ns
Reverse recovery charge	$Q_{rr}$	$dI_{DR}/dt = 100 \text{ A}/\mu\text{s}$	—	16	—	$\mu\text{C}$

## Marking









$$R_G = 25 \, \Omega$$

$$V_{DD} = 90 \, V, L = 4.3 \, mH$$

$$E_{AS} = \frac{1}{2} \cdot L \cdot I^2 \cdot \left( \frac{B_{VDSS}}{B_{VDSS} - V_{DD}} \right)$$

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20070701-EN GENERAL

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